

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)				
60	0.076 at V _{GS} = 4.5 V	7.1	29 nC				
	0.088 at V _{GS} = 10 V	6.7	29110				

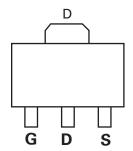
FEATURES

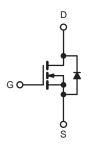
- Halogen-free
- TrenchFET[®] Power MOSFET



APPLICATIONS

· Load Switches for Portable Devices





N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	60	V		
Gate-Source Voltage	V_{GS}	± 20			
	T _C = 25 °C		7.1 ^a		
Continuous Drain Current (T _J = 150 °C)	$T_C = 70 ^{\circ}C$	I _D	7 ^a		
Commission Plant Carrent (1) = 100 °C)	T _A = 25 °C	υ.	8.7 ^{a, b, c}		
	T _A = 70 °C		7 ^{a, b, c}	A	
Pulsed Drain Current		I _{DM}	30		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	7.2		
Continuous Source-Diain Diode Current	T _A = 25 °C	'5	6.1 ^{b, c}		
	T _C = 25 °C		6.3		
Maximum Power Dissipation	T _C = 70 °C	P _D	4	w	
Maximum Fower Dissipation	T _A = 25 °C	' D	2.5 ^{b, c}	VV	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Tempera	ature) ^{e, f}		260		

THERMAL RESISTANCE RATINGS								
Parameter	Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{a, c, d}	t ≤ 5 s	R _{thJA}	40	50	°C/W			
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	15	20	0/11			

- a. Package limited, T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 95 °C/W.
- e. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

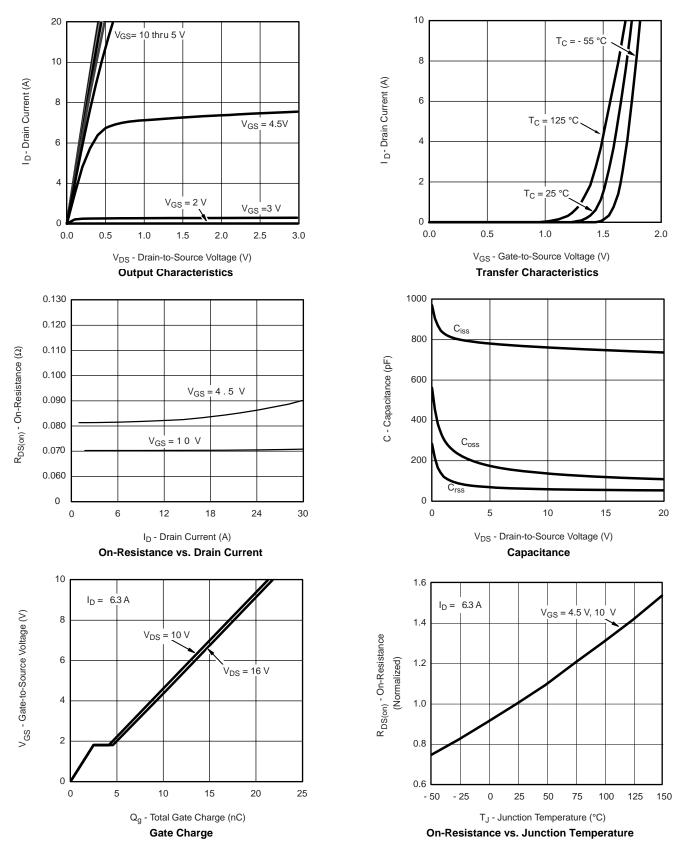


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	<u>l</u>		I.			•	
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 - 250 uA		25			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{D} = 250 \mu A$		- 4.0		mV/°C	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.5		3.0	٧	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zana Oata Wallana Basis Oamad		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 6.3 \text{ A}$		0.076		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$		0.088			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, I_D = 6.3 \text{ A}$		45		S	
Dynamic ^b	<u> </u>			<u> </u>		1	
Input Capacitance	C _{iss}			810			
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		120		pF	
Reverse Transfer Capacitance	C _{rss}			100		1	
Total Cata Chausa	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 6.3 \text{ A}$		22	33	nC	
Total Gate Charge				10	15		
Gate-Source Charge	Q_{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_D = 6.3 A		2.5			
Gate-Drain Charge	Q_{gd}			1.7			
Gate Resistance	R_g	f = 1 MHz		2.4		Ω	
Turn-on Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.5 Ω		10	15	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7$ A, $V_{GEN}=4.5$ V, $R_g=1$ Ω		35	55		
Fall Time	t _f			12	20		
Turn-on Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	$V_{DD} = 10 \text{ V, } R_L = 1.5 \Omega$ $I_D \cong 6.7 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \Omega$		12	20		
Turn-Off Delay Time	t _{d(off)}			25	40		
Fall Time	t _f			10	15	1	
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			7.2	۸	
Pulse Diode Forward Current	I _{SM}				30	A	
Body Diode Voltage	V_{SD}	$I_S = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			20	40	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 6.7 A dl/dt = 100 A/up T = 25.90		10	20	nC	
Reverse Recovery Fall Time	t _a	$I_F = 6.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		10			
Reverse Recovery Rise Time	t _b			10		ns	

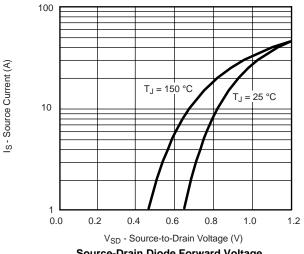
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

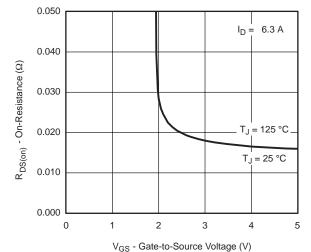
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





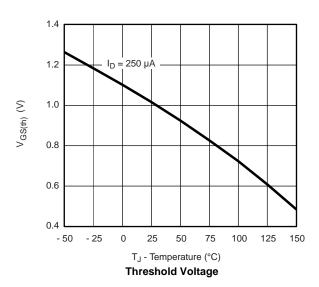


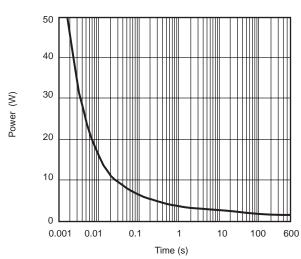




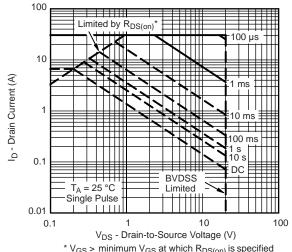
Source-Drain Diode Forward Voltage







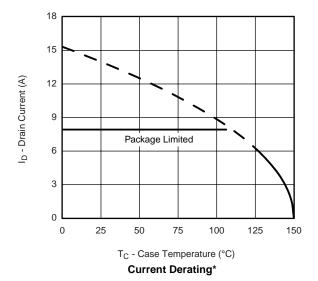


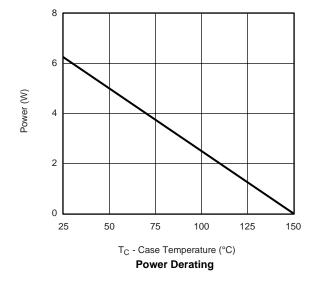


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

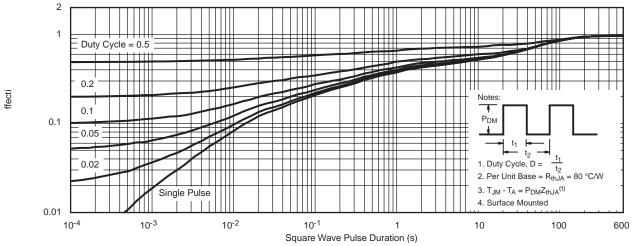




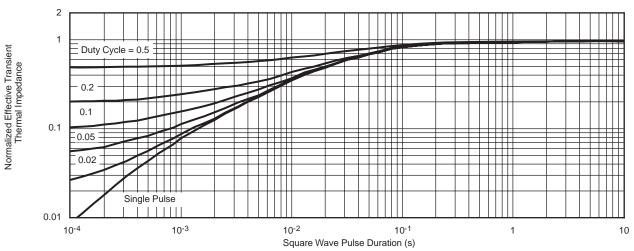


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





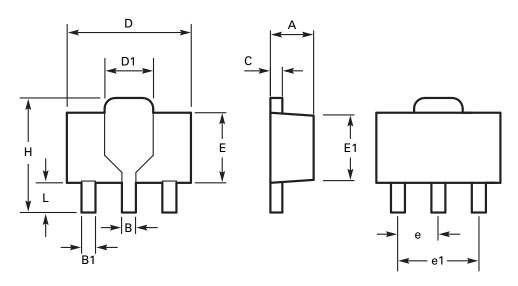
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



Package outline - SOT89



DIM	DIM Millimeters		Inches		DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	1.40	1.60	0.550	0.630	Е	2.29	2.60	0.090	0.102
В	0.44	0.56	0.017	0.022	E1	2.13	2.29	0.084	0.090
B1	0.36	0.48	0.014	0.019	е	1.50 BSC		0.059 BSC	
С	0.35	0.44	0.014	0.017	e1	3.00 BSC		0.118 BSC	
D	4.40	4.60	0.173	0.181	Н	3.94	4.25	0.155	0.167
D1	1.62	1.83	0.064	0.072	L	0.89	1.20	0.035	0.047

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches



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